# **Single Inverter**

The NL17SZ04E is an inverter in three tiny footprint packages. The device performs much as LCX multi-gate products in speed and drive.

#### **Features**

- Tiny SOT-353 Package
- 24 mA Sink and Source Output Capability
- Over-Voltage Tolerant Inputs and Outputs
- Chip Complexity: FETs = 20
- Designed for 1.65 V to 5.5 V V<sub>CC</sub> Operation
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

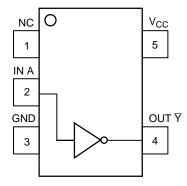


Figure 1. Pinout (Top View)

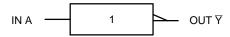


Figure 2. Logic Symbol



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SOT-353/SC70-5/SC-88A DF SUFFIX CASE 419A



**MARKING** 

L5 = Specific Device Marking

M = Date Code\*

= Pb–Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

#### **PIN ASSIGNMENT**

Pin	Function
1	NC
2	IN A
3	GND
4	OUT ₹
5	V <sub>CC</sub>

#### **FUNCTION TABLE**

Input	Output
Α	Y
L	Н
Н	L

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

## **MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit	
V <sub>CC</sub>	DC Supply Voltage	-0.5 to +6.5	V	
VI	DC Input Voltage	-0.5 to +6.5	V	
Vo	DC Output Voltage Active Mode, High or Low State (Note 1) Power–Down Mode (V <sub>CC</sub> = 0 V)		V	
I <sub>IK</sub>	DC Input Diode Current V <sub>I</sub> < GND	-50	mA	
I <sub>OK</sub>	DC Output Diode Current V <sub>O</sub> < GND	-50	mA	
IO	DC Output Sink Current	±50	mA	
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100	mA	
I <sub>GND</sub>	DC Ground Current per Supply Pin	±100	mA	
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C	
TL	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C	
TJ	Junction Temperature Under Bias	+150	°C	
$\theta_{JA}$	Thermal Resistance (Note 2)	350	°C/W	
P <sub>D</sub>	Power Dissipation in Still Air at 85°C	186	mW	
MSL	Moisture Sensitivity	Level 1		
F <sub>R</sub>	Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in		
ESD	ESD Classification Human Body Model (Note 3) Charged Device Model (Note 4)		V	
I <sub>LATCHUP</sub>	Latchup Performance Above V <sub>CC</sub> and Below GND at 125°C (Note 5)	±100	mA	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. IO absolute maximum rating must be observed.

- 2. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.

  3. Tested to EIA/JESD22-A114-A, rated to EIA/JESD22-A114-B.
- 4. Tested to JESD22-C101-A.
- 5. Tested to EIA/JESD78.

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter			Max	Unit
V <sub>CC</sub>	DC Supply Voltage	Operating Data Retention	1.65 1.5	5.5 5.5	V
V <sub>IN</sub>	DC Input Voltage		0	5.5	V
V <sub>OUT</sub>	DC Output Voltage	(High or Low State) (V <sub>CC</sub> = 0 V)	0	V <sub>CC</sub> 5.5	V
V <sub>OUT</sub>	DC Output Voltage (SOT–953 Package) (High or Low State)			V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range	-55	+125	°C	
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time	$\begin{array}{c} V_{CC} = 2.5 \ V \ \pm \ 0.2 \ V \\ V_{CC} = 3.0 \ V \ \pm \ 0.3 \ V \\ V_{CC} = 5.0 \ V \ \pm \ 0.5 \ V \end{array}$	0 0 0	20 10 5	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

			V <sub>CC</sub>	$T_A = 25^{\circ}C$		-55°C ≤ T <sub>A</sub> ≤ 125°C			
Symbol	Parameter	Condition	(V)	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	High-Level Input Voltage		1.65 to 1.95 2.3 to 5.5	0.75 V <sub>CC</sub> 0.7 V <sub>CC</sub>			0.75 V <sub>CC</sub> 0.7 V <sub>CC</sub>		V
V <sub>IL</sub>	Low-Level Input Voltage		1.65 to 1.95 2.3 to 5.5			0.25 V <sub>CC</sub> 0.3 V <sub>CC</sub>		0.25 V <sub>CC</sub> 0.3 V <sub>CC</sub>	V
V <sub>OH</sub>	High-Level Output Voltage	$I_{OH} = -100 \mu A$	1.65 to 5.5	V <sub>CC</sub> – 0.1	V <sub>CC</sub>		V <sub>CC</sub> - 0.1		V
	$V_{IN} = V_{IL}$	$I_{OH} = -4 \text{ mA}$	1.65	1.29	1.52		1.29		
		I <sub>OH</sub> = -8 mA	2.3	1.9	2.1		1.9		
		I <sub>OH</sub> = -12 mA	2.7	2.2	2.4		2.2		
		I <sub>OH</sub> = -16 mA	3.0	2.4	2.7		2.4		
		I <sub>OH</sub> = -24 mA	3.0	2.3	2.5		2.3		
		$I_{OH} = -32 \text{ mA}$	4.5	3.8	4.0		3.8		
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>OL</sub> = 100 μA	1.65 to 5.5		0.0	0.1		0.1	V
	$V_{IN} = V_{IH}$	I <sub>OH</sub> = 4 mA	1.65		0.08	0.24		0.24	
		I <sub>OL</sub> = 8 mA	2.3		0.20	0.3		0.3	
		I <sub>OL</sub> = 12 mA	2.7		0.22	0.4		0.4	
		I <sub>OL</sub> = 16 mA	3.0		0.28	0.4		0.4	
		I <sub>OL</sub> = 24 mA	3.0		0.38	0.55		0.55	
		I <sub>OL</sub> = 32 mA	4.5		0.42	0.55		0.55	
I <sub>IN</sub>	Input Leakage Current	V <sub>IN</sub> = 5.5 V or GND	1.65 to 5.5		±0.1			±1.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	V <sub>IN</sub> = 5.5 V or V <sub>OUT</sub> = 5.5 V	0			1		10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> = 5.5 V or GND	5.5			1		10	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## AC ELECTRICAL CHARACTERISTICS $t_R = t_F = 2.5 \text{ ns}$

				Т	A = 25°C	;	-55°C ≤ T	<u> 4</u> ≤ 125°C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay (Figure 3 and 4)	$R_L = 1 \text{ M}\Omega$ , $C_L = 15 \text{ pF}$	1.65 1.8		5.3 4.4	11.4 9.5		12.0 10.0	ns
		$R_L = 1 \text{ M}\Omega, C_L = 15 \text{ pF}$	2.5 ± 0.2		3.5	6.5		7.0	
		$R_L = 1 \text{ M}\Omega, C_L = 15 \text{ pF}$	$3.3 \pm 0.3$		2.1	4.5		4.7	
		$R_L = 500 \Omega, C_L = 50 pF$			2.9	5.5		5.2	
		$R_L = 1 \text{ M}\Omega, C_L = 15 \text{ pF}$	$5.0 \pm 0.5$		1.8	3.9		4.1	
		$R_L = 500 \Omega, C_L = 50 pF$			2.4	4.3		4.5	

## **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Condition	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 5.5 \text{ V}, V_{I} = 0 \text{ V or } V_{CC}$	>2.5	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 6)	10 MHz, $V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$ 10 MHz, $V_{CC}$ = 5.5 V, $V_{I}$ = 0 V or $V_{CC}$	9 11	pF

<sup>6.</sup>  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$ .  $C_{PD}$  is used to determine the no–load dynamic power consumption;  $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$ .

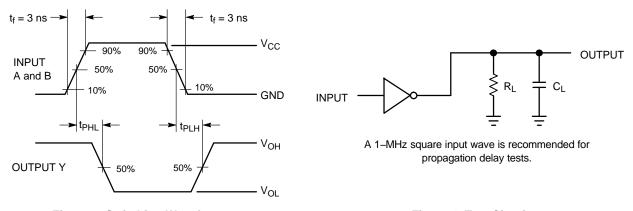


Figure 3. Switching Waveform

Figure 4. Test Circuit

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NL17SZ04EDFT2G	SC-88A/SOT-353/SC-70-5 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

## SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE L

NOTES

DIM

D

G

Н

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.

INCHES

MIN MAX

0.071 0.087

0.031 0.043 0.004 0.012

0.026 BSC

0.004 0.010

0.004 0.012

0.008 REF

S 0.079 0.087

0.004

**B** | 0.045 | 0.053

419A-01 OBSOLETE. NEW STANDARD 419A-02. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE

MILLIMETERS

MIN MAX

0.10 0.30

0.10 0.25

0.10 0.30

0.20 REF 2.00 2

0.65 BSC

2.20

1.35

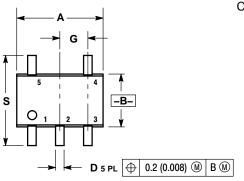
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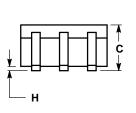
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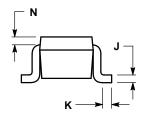
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1.15

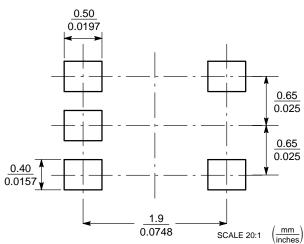
0.80







#### **SOLDER FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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